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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) Yamamoto, et al.
Serial No.: 09/600,931
Confirmation No.: Unassigned
Filed: July 21, 2000
For: DAMASCENE
INTERCONNECTION AND
SEMICONDUCTOR
DEVICE

Examiner: Eugene Lee
Group Art Unit: 2815
Docket: 362-43 PCT/US/RCE
Dated: June 7, 2002

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Commissioner for Patents
Washington, DC 20231

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20231 on June 7, 2002

Dated: 6/7/02

Neunda Kerrige

REPLY TO FINAL OFFICE ACTION

Sir:

In response to the final Office Action mailed October 9, 2001 and the Advisory Action mailed April 5, 2002, please amend the above-identified application as follows. A Request for Continued Examination is being submitted herewith.

IN THE CLAIMS:

Please amend Claims 1 and 8 by rewriting the same as follows:

1. (Twice Amended) A damascene interconnection comprising:
an interconnection trench formed in an insulating film and a pad trench
communicating therewith;

Dk
congr
subp1